SDC612

General Description

SDC612 is a high-performance current mode control IC designed for AC/DC convertor, which supplies about continuous 6W output power at the universal AC input range from 85V to 265V.

Features

- Built-in oscillator
- Built-in high voltage power transistor of 700V
- Cycle-by-cycle current limit
- Very low power consumption under no load
- Internal slope compensation and feedback compensation
- Over load protection
- Built-in high precise current limit with temperature compensation
- Over temperature protection
- Low startup and operating current
- VCC over-voltage clamp
- 6W output power at the universal AC input range,8W output power at AC input 220V
- Package: DIP-8

Applications

- Offline AC/DC flyback converter
- Adaptor/Charger for cell and other portable
 Apparatus

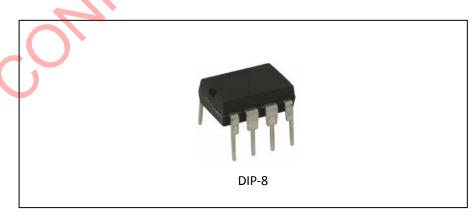


Figure 1. Package Type

SDC612

Pin Configuration

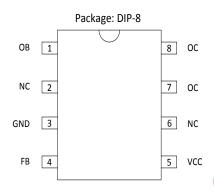


Figure 2. Pin Configuration

Pin Number	Pin Name	Function		
1	ОВ	Startup current input, connecting to startup resistor		
2	NC	No connection		
3	GND	Ground		
4	FB	Feedback pin		
5	VCC	Supply voltage pin		
6	NC	No connection		
7,8	OC	Output of HV transistor, connecting to primary wind of transformer		

Table 1. Pin Configuration

SDC612

Functional Block Diagram

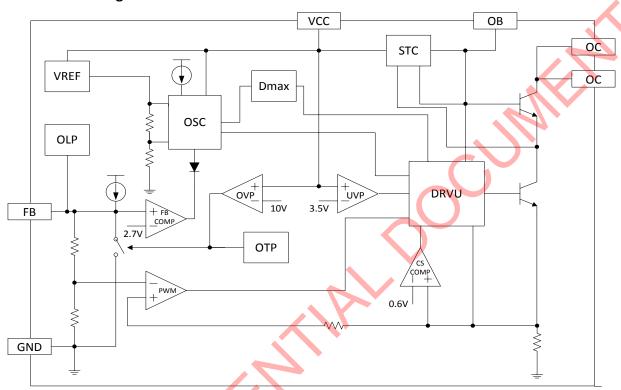
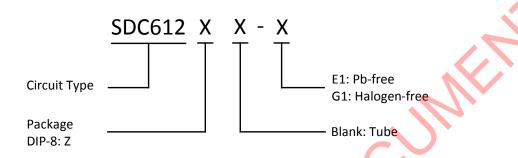


Figure 3. Functional Block Diagram

SDC612

Ordering Information



Dockogo	Tommoroturo	Part Number		Mar	Docking Type	
Package	Temperature	Pb-free	Halogen-free	Pb-free	Halogen-free	Packing Type
DIP-8	-40℃~85℃	SDC612Z-E1	SDC612Z-G1	SDC612	SDC612G	Tube



SDC612

Absolute Maximum Ratings (NOTE: Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device.)

permanent damage to the device.			
Parameter	Symbol	Value	Unit
Power supply voltage VCC	V _{cc}	18	V
Collector current	I _C	1.5	Α
Endurance voltage of OC collector	V_{CB}	-0.3~700	V
Peak value of switching current	lp	330	mA
Total dissipation power	P _D	1000	mW
Operating Junction Temperature	T _J	-40~150	°C
Storage temperature range	T _{STG}	-55~150	°C
Lead temperature (soldering, 10sec)	T _{LEAD}	260	°C
Latch-up test per JEDEC 78	-	200	mA
ESD, HBM model per Mil-Std-883, Method 3015	НВМ	2000	V
ESD, MM model per JEDEC EIA/JESD22-A115	MM	200	V

Table 2. Absolute Maximum Ratings

Recommended Operating Conditions

Parameter	Symbol	Min	Max	Unit
Power supply voltage, VCC	V _{cc}	4.8	9.0	V
Operating temperature	Та	-40	85	°C

Table 3. Recommended Operating Conditions

December, 2013 Rev. 1.2



SDC612

Electrical Characteristics (Ta=25°C, V_{CC} =7.0V, unless otherwise specified)

Par	Symbol	Conditions	Min	Тур	Max	Unit		
	Output Section							
On-state saturation vo	$V_{\scriptscriptstyle SAT}$	I _{oc} =290mA	-	- 4	1	V		
Output rise time		$T_{\rm r}$	C _L =1nF	-	-	75	ns	
Output fall time		T_{f}	C _L =1nF	-	IN	75	ns	
HV start-up current		${ m I}_{ ext{STC}}$	-	1).	2.6	mA	
		Oscillator Sec	tion					
Oscillation frequency		$\mathbf{f}_{ ext{OSC}}$	-	55	61	68	kHz	
Temperature Stability		$\triangle F_v$	V _{CC} =4.8V~9V	-	-	1	%	
Temperature Stability		$\triangle F_{\scriptscriptstyle T}$	Ta=0°C~85°C	-	-	1	%	
	ı	Feedback Sec	tion					
	Pull-up current	$I_{\rm FB}$	V _{FB} =2.5V	0.40	0.55	0.70	mA	
Input impedance	Pull-down resistance	R_{FB}	-	10	15	20	kΩ	
PSRR	PSRR		V _{CC} =4.8V~9V	-	60	70	dB	
	Curr	ent Sampling	Section					
Over current threshold	V _{TH_OC}	-	0.55	0.60	0.65	V		
Current limit	I _{TH_OC}	-	0.27	0.29	0.31	Α		
PSRR	-	-	-	60	70	dB		
Over current detection	and control delay	T_{D}	-	-	150	250	ns	
		PWM Section	on					
Maximum duty cycle		D _{MAX}	V _{FB} =4.0V	52	57	62	%	
Minimum duty cycle		D_{MIN}	-	-	1.5	-	%	
	Power Current Section							
Startup leakage curren	$I_{ ext{ST}}$	-	-	15	50	uA		
Static operation currer	$I_{ ext{OP}}$	V _{FB} =0V, V _{CC} =8V	2.0	2.8	4.0	mA		
Startup threshold volta	$V_{\rm ST}$	-	8.6	9.0	9.4	V		
Minimal operating volt	V _{UV}	-	3.2	3.5	3.8	V		
Restart voltage	V _{RST}	-	1.7	2.0	2.4	V		
Over voltage protectio	n	V_{ov}	-	9.6	10	10.6	V	



SDC612

Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
OTP Section							
Thermal shutdown temperature	T_{OTP}	-	-	150		°C	
	BJT Sectio	n					
Collector cutoff current	$I_{ ext{CBO}}$	V _{CB} =700V, I _E =0	-	-	0.1	mA	
Collector-emitter cutoff current	$I_{ ext{CEO}}$	V _{CE} =400V, I _B =0	-	11	0.1	mA	
Collector-base cutoff current	$I_{ ext{EBO}}$	V _{EB} =9V, I _C =0		<u></u>	0.1	mA	
Collector-base breakdown voltage	V_{CBO}	I _C =0.1mA	700	-	-	V	
Collector-emitter sustain voltage	V_{CEO}	I _C =1mA	400	-	-	V	
Collector-base sustain voltage	V_{EBO}	I _E =0.1mA	9	-	-	٧	
DC current gain	$h_{ ext{FE}}$	V _{CE} =5V, I _C =0.5A	15	-	30	-	
Collector-emitter saturation voltage	V _{CE_STA}	I _C =1A, I _B =0.25A		0.3	0.9	٧	
Base-emitter saturation voltage	V _{BE_STA}	I _C =1A, I _B =0.25A		0.9	1.2	V	

Table 4. Electrical Characteristics

SDC612

Function Description

Startup control

During Startup phase, reference voltage, the oscillator and all protection circuits are OFF. Startup current of SDC612 is designed to be very low so that VCC could be charged up above UVLO threshold level and device starts up quickly. A large startup resistor can therefore be used to minimize the power loss yet achieve a reliable startup in application.

PWM control

The peak current (sensed on the IS pin) is set by the voltage on FB pin. By comparing the voltage on FB pin and the IS ramp voltage, the duty-cycle of the PWM modulator is thus adjusted to provide the necessary load current at the desired output voltage. FB can be controlled by internal control circuit and external feedback circuit.

VCC over voltage protection

VCC over voltage protection circuit is integrated into IC. When VCC voltage reaches 9.8V(TYP), FB voltage is pulled down via internal control circuit, then the PWM switching is shut off. When VCC voltage goes down below 9.8V(TYP), the switching is reactivated. The VCC over voltage protection ensures IC to operate reliably.

Current limit

The output is shut off to limit the power when voltage of IS Pin exceeds Current sense threshold voltage.

Green mode control

Under no-load and light-load condition, the switching frequency internally reduces to lower the switching power loss and improve the conversion efficiency. If FB is less than 2.7V(Typ), the cycle of the oscillator will increase with it, the less FB is, the wider the cycle of the oscillator is, until the oscillation stop.

Power transistor drive

During the ON cycle, OB pin supplies base current for the power transistor, OE pulls down the emitter of the power transistor to IS, and OB is adaptive to the IS current. If the current of IS exceeds the specified current of FB, SDC612 will turn into the OFF cycle. During the OFF cycle, OB is pulled down, the power transistor will shut off.

Over temperature protection

When IC's internal temperature reaches 150°C, FB voltage will be pulled down by internal control circuit, the switching frequency decreases or shut off. This protection protects the IC from over temperature.

SDC612

Typical Application

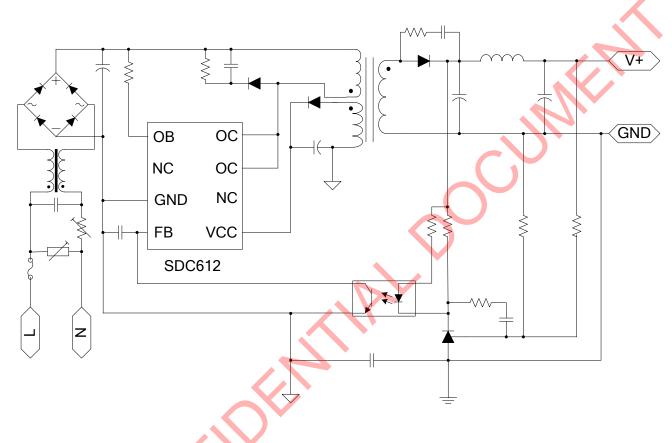
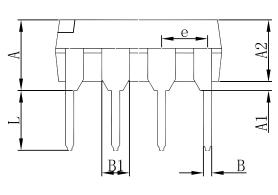
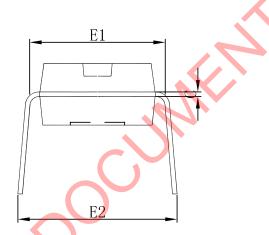


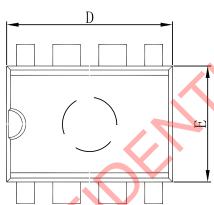
Figure 4. Typical Application

SDC612

Package Dimension DIP-8







Symbol	Dimensions In Millimeters		Dimension	s In Inches
	Min	Max	Min	Max
A	3.710	4.310	0.146	0.170
A1	0.510		0.020	
A2	3.200	3.600	0.126	0.142
В	0.380	0.570	0.015	0.022
B1	1.524	(BSC)	0.060	(BSC)
С	0.204	0.360	0.008	0.014
D	9.000	9.400	0.354	0.370
E	6.200	6.600	0.244	0.260
E1	7.320	7.920	0.288	0.312
e	2.540	2.540(BSC)		(BSC)
L	3.000	3.600	0.118	0.142
E2	8.400	9.000	0.331	0.354

SDC612



Shaoxing Devechip Microelectronics Co., Ltd.

http://www.sdc-semi.com/

IMPORTANT NOTICE

Information in this document is provided solely in connection with Shaoxing Devechip Microelectronics Co., Ltd. (abbr. SDC) products. SDC reserves the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at anytime, without notice. SDC does not assume any responsibility for use of any its products for any particular purpose, nor does SDC assume any liability arising out of the application or use of any its products or circuits. SDC does not convey any license under its patent rights or other rights nor the rights of others.

© 2013 Devechip Microelectronics - All rights reserved

Contact us:

Headquarters of Shaoxing Shenzhen Branch

Address: Tian Mu Road, No13, Address: 22A, Shangbu building, Nan Yuan Road, No.68,
Shaoxing city, Zhejiang province, China Futian District, Shenzhen city, Guangdong province, China

Zip code: 312000 Zip code: 518031

Tel: (86) 0575-8861 6750 Tel: (86) 0755-8366 1155
Fax: (86) 0575-8862 2882 Fax: (86) 0755-8301 8528